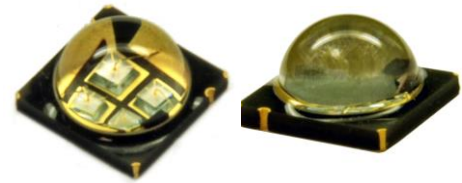


High Efficacy
365nm UV LED Emitter
LZ4-00U610



Key Features

- High Efficacy 365nm 10W UV LED
- Ultra-small foot print – 7.0mm x 7.0mm x 4.3mm
- Surface mount ceramic package with integrated glass lens
- Very low Thermal Resistance (1.8°C/W)
- Individually addressable die
- Electrically neutral thermal path
- Highest Radiant Flux density
- JEDEC Level 1 for Moisture Sensitivity Level
- Lead (Pb) free and RoHS compliant
- Reflow solderable (up to 6 cycles)
- Emitter available on [Standard](#) and [Serially](#) connected MCPCB (optional)

Typical Applications

- Curing
- Sterilization
- Medical
- Currency Verification
- Fluorescence Microscopy
- Inspection of dyes, rodent and animal contamination,
- Leak detection
- Forensics

Description

The LZ4-00U610 UV LED emitter provides superior radiometric power in the wavelength range specifically required for applications like curing, sterilization, currency verification, and various medical applications. With a 7.0mm x 7.0mm x 4.3mm ultra-small footprint, this package provides exceptional optical power density. The patented design has unparalleled thermal and optical performance. The high quality materials used in the package are chosen to optimize light output, have excellent UV resistance, and minimize stresses which results in monumental reliability and radiant flux maintenance.



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Product Nomenclature

The LZ Series part number designation is defined as follows:



Where:

- A – designates the number of LED die in the package (“4” for 4-die)
- B – designates the package level (“0” for Emitter)
- C – designates the radiation pattern (“0” for Lambertian)
- D and E – designate the color (“U6” - Typical UV Peak Wavelength = 365nm)
- F and G – designate the Power (“10” for 10W typical rating)
- H – designates the Radiant Flux bin (See Table 2)
- J and K – designate the Peak Wavelength bin (see Table 3)
- L – designates the V_F bin (See Table 4)

Ordering information:

For ordering LedEngin products, please reference the base part number. The base part number represents any of the radiant flux, peak wavelength, or forward voltage bins specified in the binning tables below. For ordering products with special bin selections, please contact a LedEngin sales representative or authorized distributor.

IPC IPC/JEDEC Moisture Sensitivity Level

Table 1 - IPC/JEDEC J-STD-20D.1 MSL Classification:

Level	Floor Life		Soak Requirements			
	Time	Conditions	Standard Time (hrs)	Standard Conditions	Accelerated Time (hrs)	Accelerated Conditions
1	Unlimited	$\leq 30^\circ\text{C}/$ 85% RH	168 +5/-0	85°C/ 85% RH	n/a	n/a

Notes for Table 1:

1. The standard soak time includes a default value of 24 hours for semiconductor manufacturer’s exposure time (MET) between bake and bag and includes the maximum time allowed out of the bag at the distributor’s facility.

Radiant Flux Bins

Table 2:

Bin Code	Minimum Radiant Flux (Φ) @ $I_F = 700\text{mA}$ ^[1,2] (mW)	Maximum Radiant Flux (Φ) @ $I_F = 700\text{mA}$ ^[1,2] (mW)
H	410	512
J	512	640
K	640	800

Notes for Table 2:

1. Radiant flux performance guaranteed within published operating conditions. LedEngin maintains a tolerance of $\pm 10\%$ on flux measurements.
2. Future products will have even higher levels of radiant flux performance. Contact LedEngin Sales for updated information.

Peak Wavelength Bins

Table 3:

Bin Code	Minimum Peak Wavelength (λ_P) @ $I_F = 700\text{mA}$ ^[1] (nm)	Maximum Peak Wavelength (λ_P) @ $I_F = 700\text{mA}$ ^[1] (nm)
U0	365	370
U1	370	375

Notes for Table 3:

1. LedEngin maintains a tolerance of $\pm 2.0\text{nm}$ on peak wavelength measurements.

Forward Voltage Bins

Table 4:

Bin Code	Minimum Forward Voltage (V_F) @ $I_F = 700\text{mA}$ ^[1,2] (V)	Maximum Forward Voltage (V_F) @ $I_F = 700\text{mA}$ ^[1,2] (V)
0	14.72	19.52

Notes for Table 4:

1. Forward Voltage is binned with all four LED dice connected in series.
2. LedEngin maintains a tolerance of $\pm 0.16\text{V}$ for forward voltage measurements for the four LEDs.

Absolute Maximum Ratings

Table 5:

Parameter	Symbol	Value	Unit
DC Forward Current ^[1]	I_F	700	mA
Peak Pulsed Forward Current ^[2]	I_{FP}	1000	mA
Reverse Voltage	V_R	See Note 3	V
Storage Temperature	T_{stg}	-40 ~ +150	°C
Junction Temperature	T_J	125	°C
Soldering Temperature	T_{sol}	180	°C
Allowable Reflow Cycles		6	
ESD Sensitivity ^[4]		> 2,000 V HBM Class 2 JESD22-A114-D	

Notes for Table 5:

- Maximum DC forward current is determined by the overall thermal resistance and ambient temperature. Follow the curves in Figure 10 for current derating.
- Pulse forward current conditions: Pulse Width \leq 10msec and Duty Cycle \leq 10%.
- LEDs are not designed to be reverse biased.
- LedEngin recommends taking reasonable precautions towards possible ESD damages and handling the LZ4-00U610 in an electrostatic protected area (EPA). An EPA may be adequately protected by ESD controls as outlined in ANSI/ESD S6.1.

Optical Characteristics @ $T_C = 25^\circ\text{C}$

Table 6:

Parameter	Symbol	Typical	Unit
Radiant Flux (@ $I_F = 700\text{mA}$)	Φ	630	mW
Peak Wavelength ^[1]	λ_P	365	nm
Viewing Angle ^[2]	$2\Theta_{1/2}$	115	Degrees
Total Included Angle ^[3]	$\Theta_{0.9}$	175	Degrees

Notes for Table 6:

- When operating the UV LED, observe IEC 60825-1 class 3B rating. Avoid exposure to the beam.
- Viewing Angle is the off axis angle from emitter centerline where the radiant power is $\frac{1}{2}$ of the peak value.
- Total Included Angle is the total angle that includes 90% of the total radiant flux.

Electrical Characteristics @ $T_C = 25^\circ\text{C}$

Table 6:

Parameter	Symbol	Typical		Unit
		1 Die	4 Dice	
Forward Voltage (@ $I_F = 700\text{mA}$)	V_F	4.1	16.4	V
Temperature Coefficient of Forward Voltage	$\Delta V_F / \Delta T_J$	-14.8		mV/°C
Thermal Resistance (Junction to Case)	$R_{\theta J-C}$	1.8		°C/W

Mechanical Dimensions (mm)

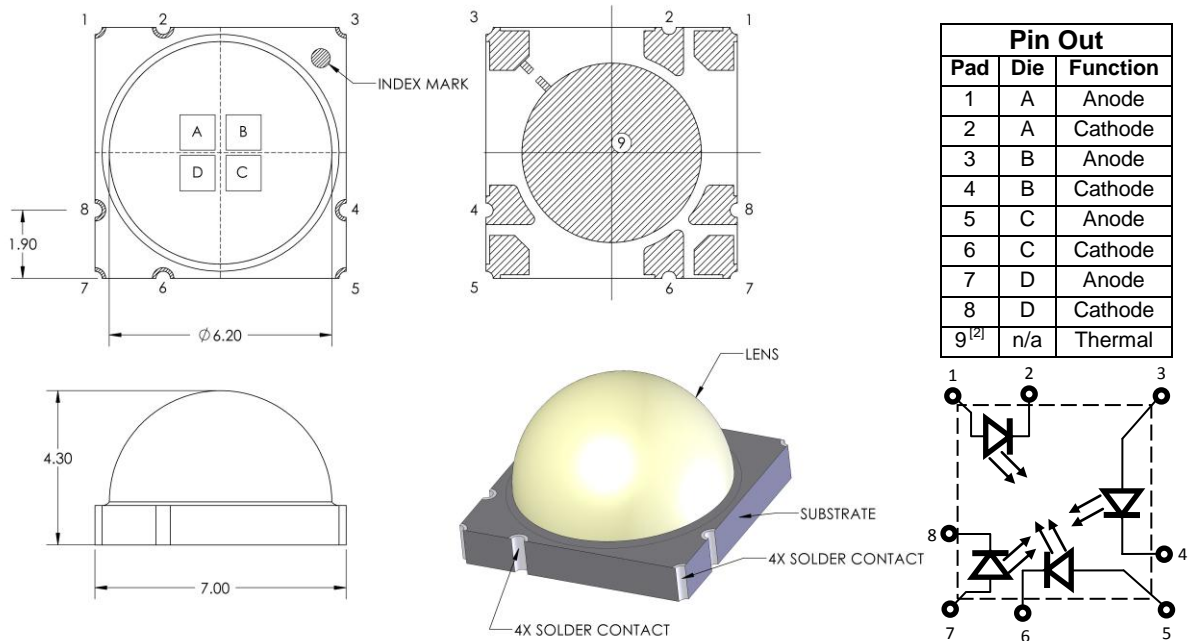


Figure 1: Package outline drawing.

Notes for Figure 1:

1. Unless otherwise noted, the tolerance = ± 0.20 mm.
2. Thermal contact, Pad 9, is electrically neutral.

Recommended Solder Pad Layout (mm)

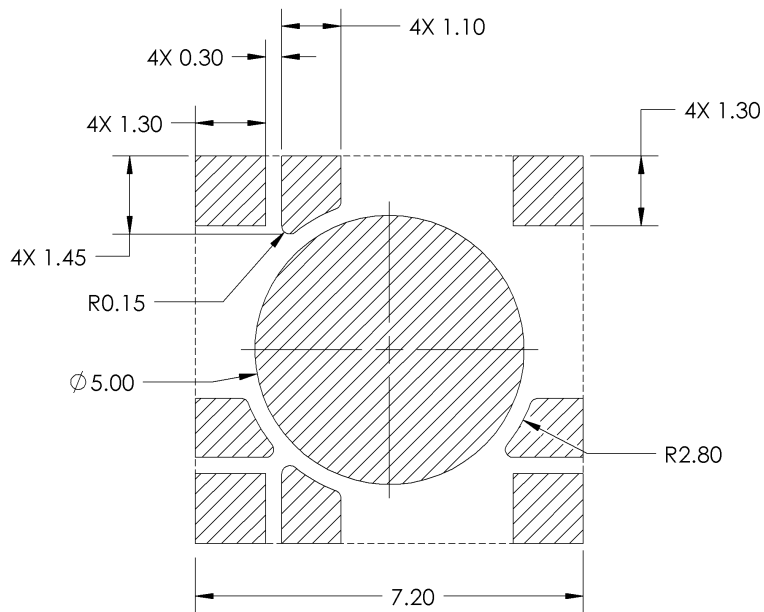


Figure 2: Recommended solder mask opening (hatched area) for anode, cathode, and thermal pad.

Note for Figure 2:

1. Unless otherwise noted, the tolerance = ± 0.20 mm.

Reflow Soldering Profile

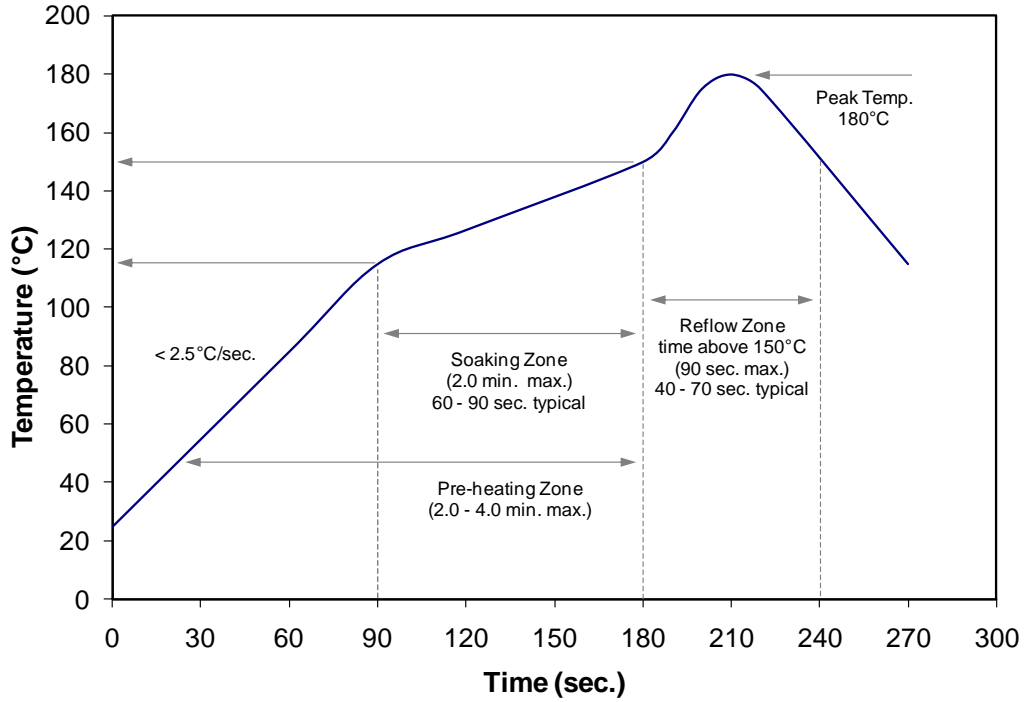


Figure 3: Reflow soldering profile for low temperature lead free soldering.

Notes for Figure 3:

1. Solder profile for low temperature solder. LedEngin recommends 58Bi-42Sn (wt.%) Solder for the LZ4-00UA10.

Typical Radiation Pattern

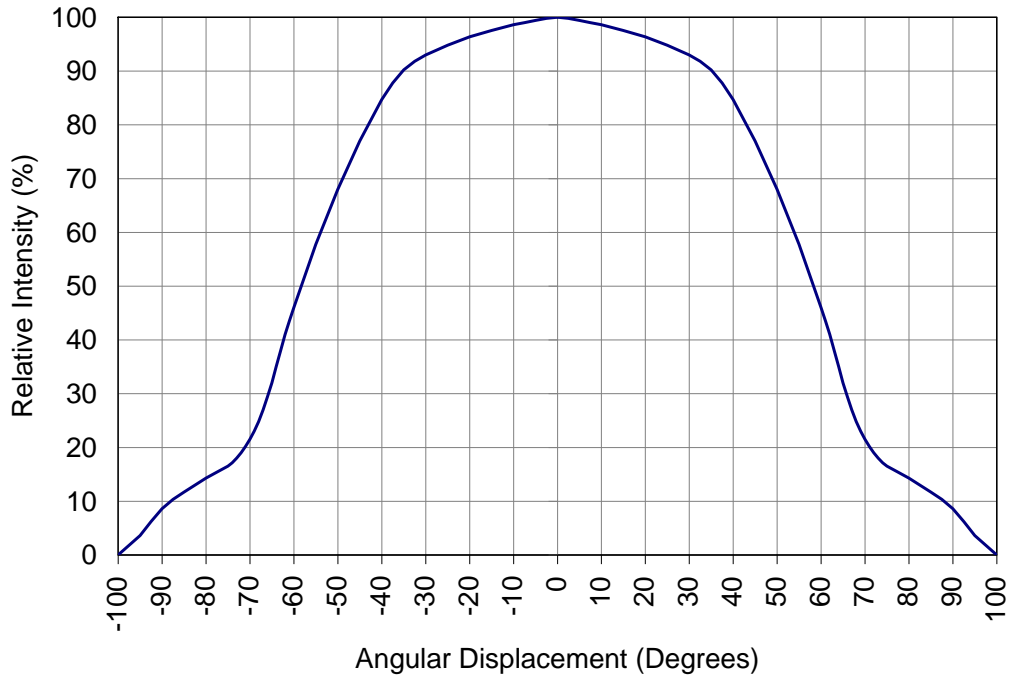


Figure 4: Typical representative spatial radiation pattern.

Typical Relative Spectral Power Distribution

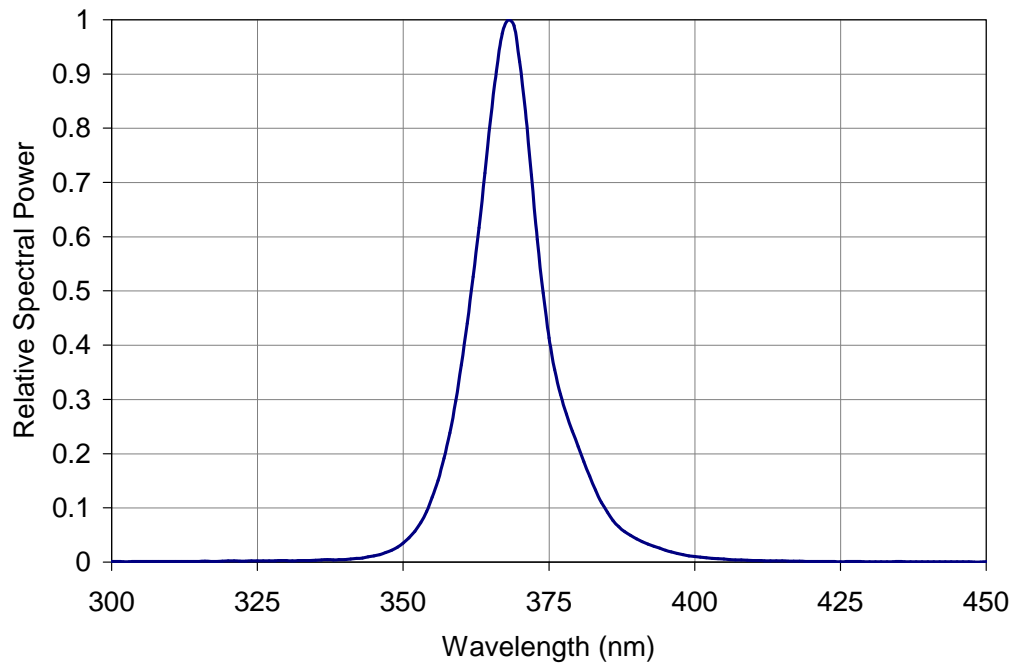


Figure 5: Typical relative spectral power vs. wavelength @ $T_C = 25^\circ\text{C}$.

Typical Peak Wavelength Shift over Temperature

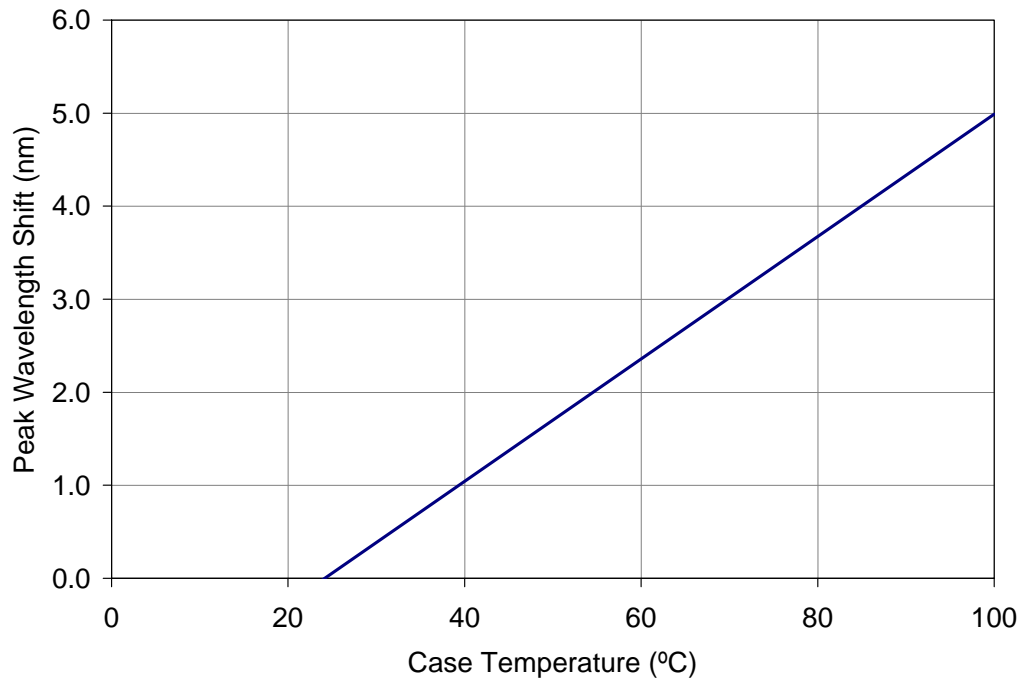


Figure 6: Typical peak wavelength shift vs. case temperature.

Typical Normalized Radiant Flux

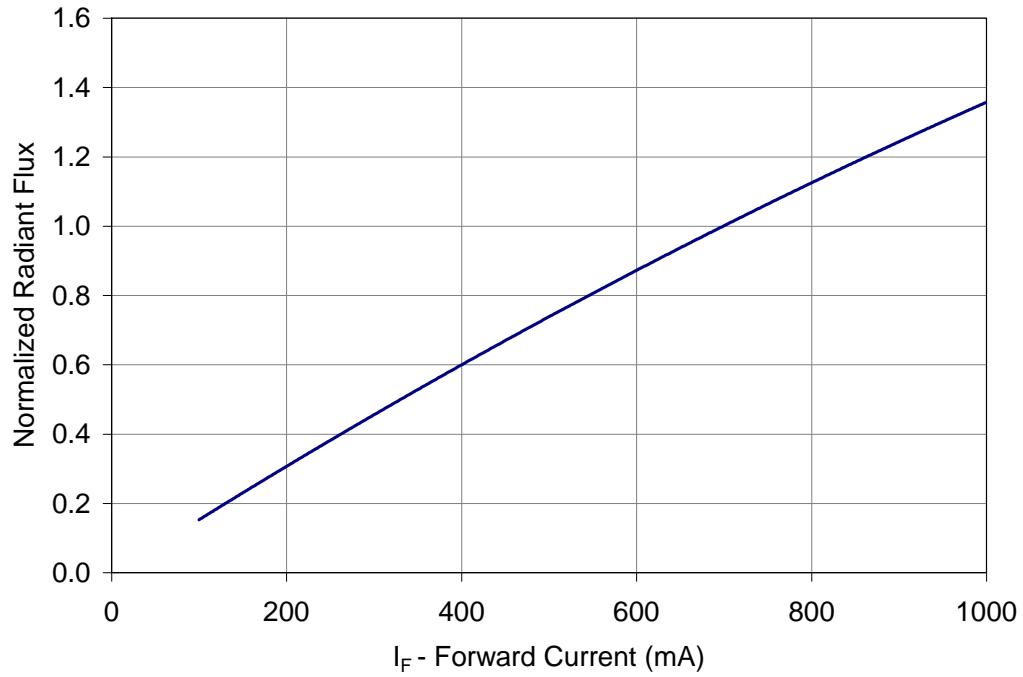


Figure 7: Typical normalized radiant flux vs. forward current @ $T_C = 25^\circ\text{C}$.

Typical Normalized Radiant Flux over Temperature

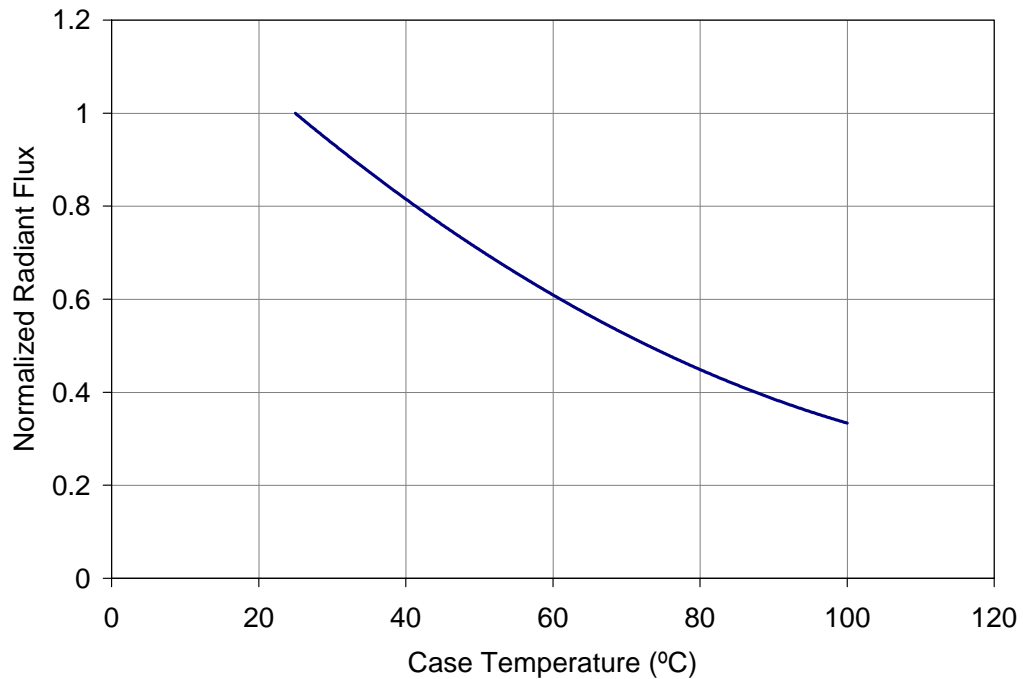


Figure 8: Typical normalized radiant flux vs. case temperature.

Typical Forward Current Characteristics

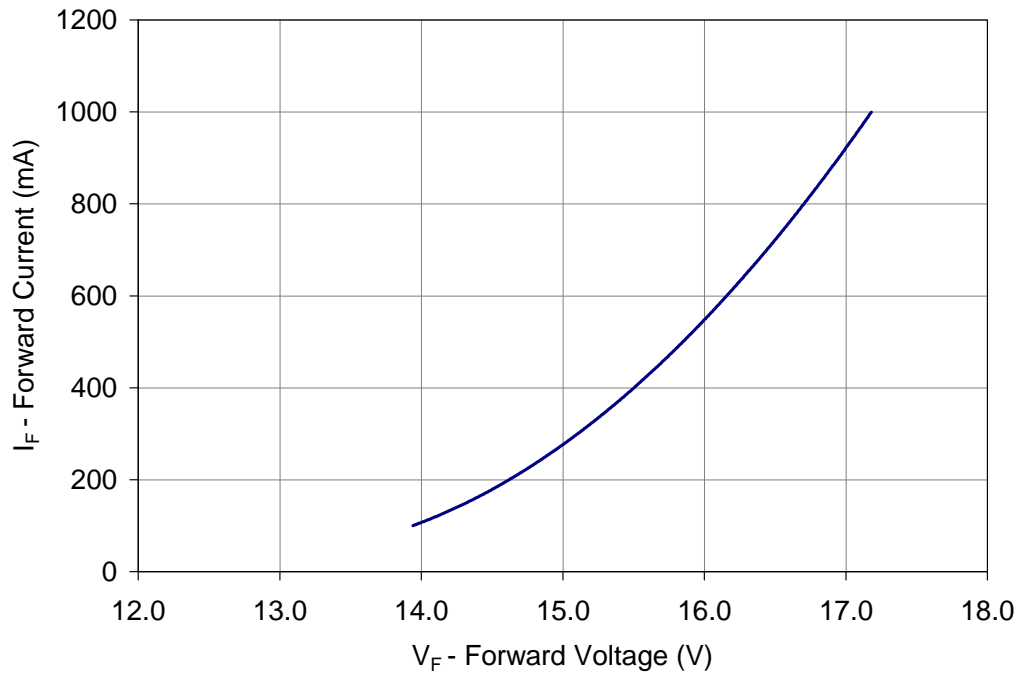


Figure 9: Typical forward current vs. forward voltage @ $T_C =$ at 25°C.

Current Derating

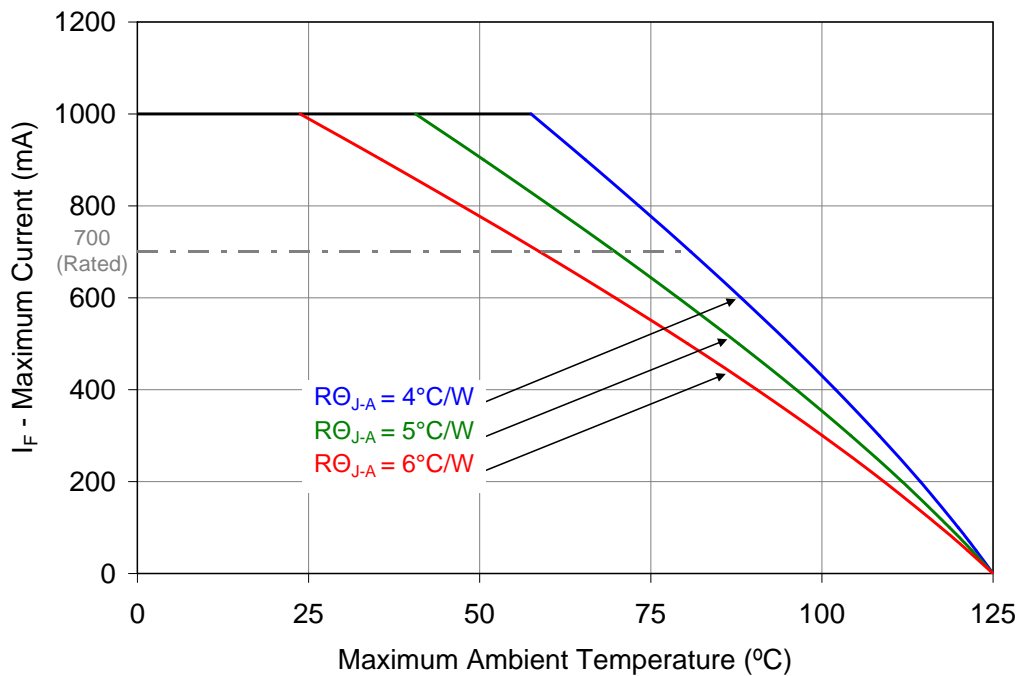


Figure 10: Maximum forward current vs. ambient temperature based on $T_{J(\text{MAX})} = 125^\circ\text{C}$.

Notes for Figure 10:

1. $R\theta_{J-C}$ [Junction to Case Thermal Resistance] for the LZ4-00UA10 is typically 1.8°C/W .
2. $R\theta_{J-A}$ [Junction to Ambient Thermal Resistance] = $R\theta_{J-C} + R\theta_{C-A}$ [Case to Ambient Thermal Resistance].

Emitter Tape and Reel Specifications (mm)

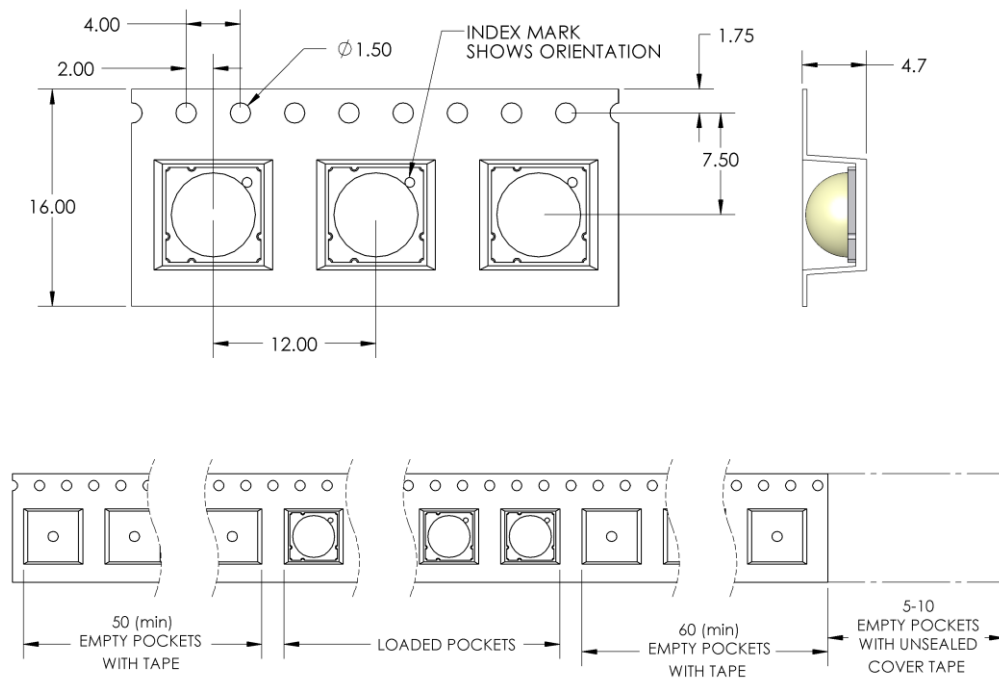


Figure 11: Emitter carrier tape specifications (mm).

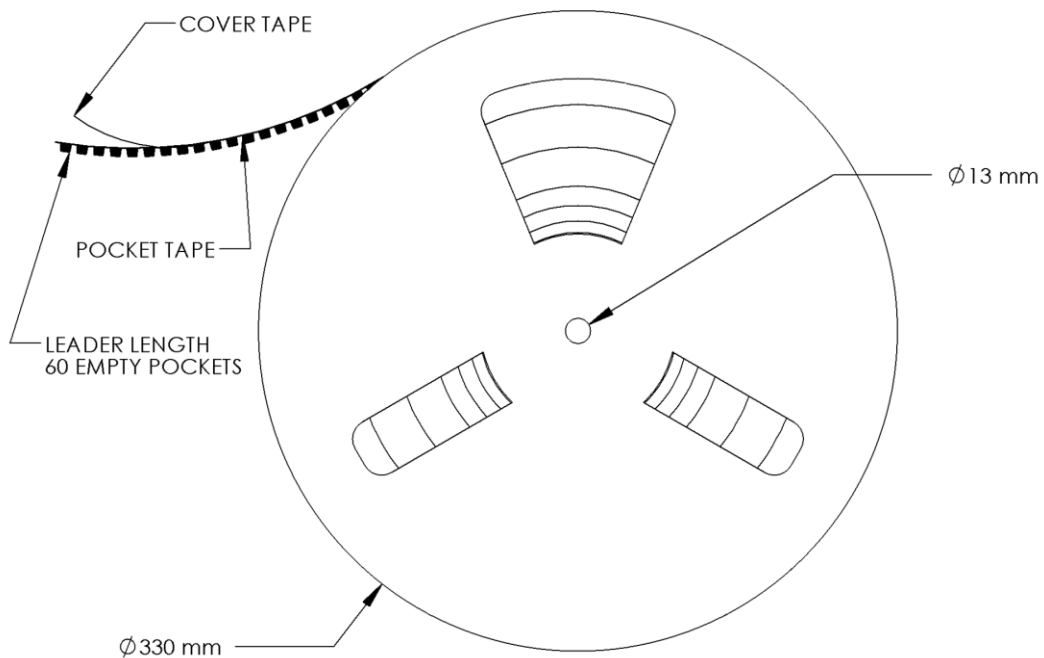


Figure 12: Emitter Reel specifications (mm).

Notes:

1. Reel quantity minimum: 100 emitters. Reel quantity maximum: 2000 emitters
2. Packaging contains UV caution labels. Avoid exposure to the beam and wear appropriate protective eyewear when operating the UV LED.

Company Information

LedEngin, Inc. is a Silicon Valley based solid-state lighting company specializing in the development and manufacturing of unprecedented high-power LED emitters, modules and replacement lamps. LedEngin's packaging technologies lead the industry with products that feature lowest thermal resistance, highest flux density and consummate reliability, enabling compact and efficient solid state lighting solutions.

LedEngin's LED emitters range from 3W to 90W with ultra-compact footprints and are available in single color products including Cool White, Neutral White, Warm White, Red, Green, Blue, Amber, Deep Red, Far Red, Dental Blue and UV as well as multi-color products with RGB, RGBA and RGBW options. LedEngin's brightest White LEDs are capable of emitting 5,500 lumens.

LedEngin's robust emitters are at the core of its unique line of modules and replacement lamps producing unmatched beam quality resulting in true Lux on Target™ for a wide variety of spot and narrow flood directional lighting applications.

LedEngin is committed to providing products that conserve natural resources and reduce greenhouse emissions.

LedEngin reserves the right to make changes to improve performance without notice.

Please contact Sales@ledengin.com or (408) 492-0620 for more information.